

Certificate

PROFIBUS Nutzerorganisation e.V. grants to

Texas Instruments Deutschland GmbH
Haggertystr. 1, 85356 Freising, Germany

the Certificate No: **Z10659** for the PROFINET IO Device:

Model Name: AM3359 Profinet Evaluation Kit
Revision: SW/FW: T 1.0.2; HW: 1
Identnumber: 0x0127; 0x0310
GSD: GSDML-V2.31-MOLEX_TI-AM335xProfinet_SDK-20150609.xml
DAP: DIM 1: Molex-TI sample device, 0x1010 0000

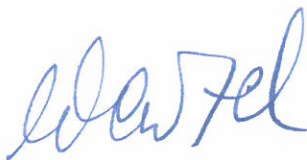
This certificate confirms that the product has successfully passed the certification tests with the following scope:

<input checked="" type="checkbox"/>	PNIO_Version	V2.32
<input checked="" type="checkbox"/>	Conformance Class	C Optional Features: IRT
<input checked="" type="checkbox"/>	Netload Class	III
<input checked="" type="checkbox"/>	PNIO_Tester_Version	V2.3.5
<input checked="" type="checkbox"/>	Tester	SIEMENS AG, Fürth, Germany PN346-1, IRT086-1

This certificate is granted according to the document:

“Framework for testing and certification of PROFIBUS and PROFINET products”.

For all products that are placed in circulation by June 19, 2018 the certificate is valid for life.

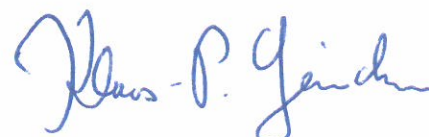


(Official in Charge)

Board of PROFIBUS Nutzerorganisation e. V.



(Karsten Schneider)

(K.-P. Lindner)

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